

# Power management (dual transistors)

Parameter	Tr1 and Tr2
V <sub>CEO</sub>	-50V
I <sub>C</sub>	-100mA

## Outline

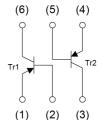
. (6)	SOT-563
(1) (2) (3)	(1) (2) (3) (4)
VT6T2	EMT52
(VMT6)	(EMT6)

#### Features

- 1) General Purpose.
- 2) Two 2SAR523 chips in one package.
- 3) Transister elements are independent, eliminating interface.
- 4) Mounting cost and area can be cut in half.

## •Inner circuit

- (1) Tr1 Emitter
- (2) Tr1 Base
- (3) Tr2 Collector
- (4) Tr2 Emitter
- (5) Tr2 Base
- (6) Tr1 Collector



## Application

SWITCH, LED DRIVER

## Packaging specifications

<u> </u>							
Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
VT6T2	(VMT6)	1212	T2R	180	8	8000	T2
EMT52	SOT-563 (EMT6)	1616	T2R	180	8	8000	T52

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

<It is the same ratings for the Tr1 and Tr2>

Parameter			Symbol	Values	Unit
Collector-base voltage		$V_{CBO}$	-50	V	
Collector-emitter voltage		$V_{CEO}$	-50	V	
Emitter-base voltage		$V_{\text{EBO}}$	-5	V	
		I <sub>C</sub>	-100	mA	
Collector current			I <sub>CP</sub> *1	-200	mA
Power dissipation	VT6T2		D *2*3	150	\A/
EMT52			P <sub>D</sub> *2*3	150	mW
Junction temperature		T <sub>j</sub>	150	°C	
Range of storage temperature		T <sub>stg</sub>	-55 to +150	°C	

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

<It is the same characteristics for the Tr1 and Tr2>

Parameter	Cumphal	Conditions	Values			I India
Parameter Symbol Conditions		Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	$V_{CBO}$ $I_C = -50\mu A$		-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	BV <sub>CEO</sub> I <sub>C</sub> = -1mA		-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = -50μA	-5	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -50V	ı	-	-100	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -5V	-	-	-100	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$V_{CE(sat)}$ $I_C = -50$ mA, $I_B = -5$ mA		-150	-400	mV
DC current gain	h <sub>FE</sub>	$V_{CE} = -6V, I_{C} = -1mA$	120	-	560	-
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = -10V, I <sub>E</sub> = 10mA, f = 100MHz	-	300	-	MHz
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0A, f = 1MHz	-	1.6	-	pF

<sup>\*1</sup> Pw=10ms Single Pulse

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3 120</sup>mW per element must not be exceeded.

**VT6T2 / EMT52** 

## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>

Fig.1 Ground Emitter Propagation

Characteristics

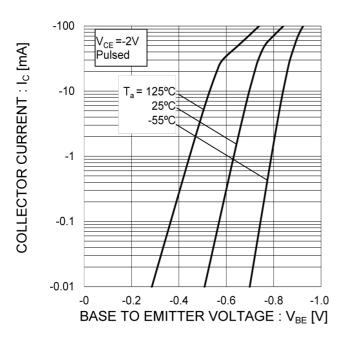
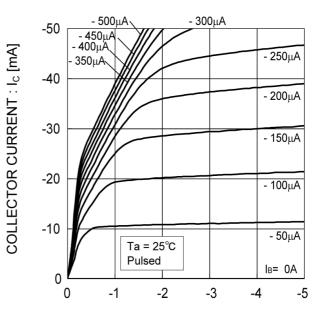


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector Current (I)

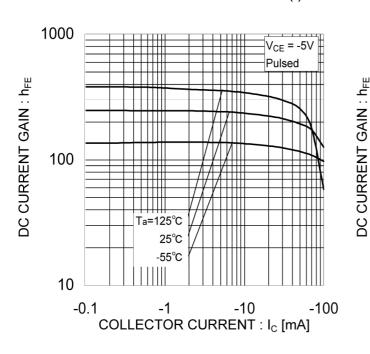
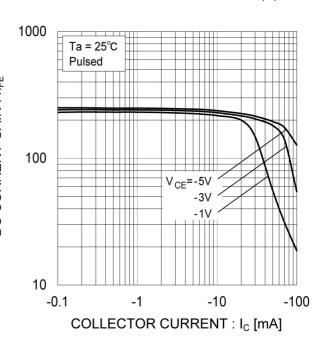


Fig.4 DC Current Gain vs. Collector Current (II)



**VT6T2 / EMT52** 

## ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For Tr1 and Tr2 in common>

Fig.5 Collector-Emitter Saturation
Voltage vs. Collector Current (I)

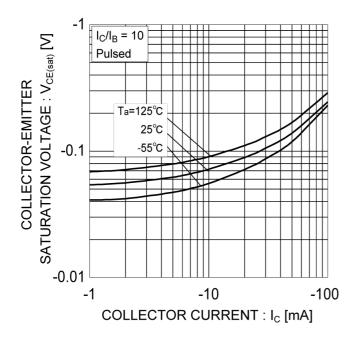


Fig.6 Collector-Emitter Saturation

Voltage vs. Collector Current (II)

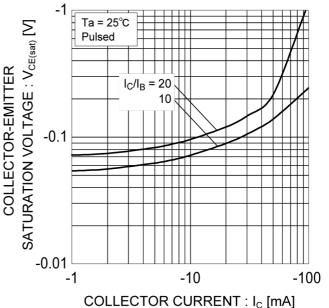


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

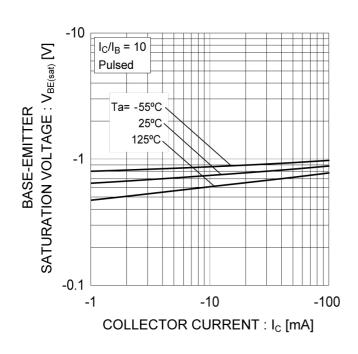
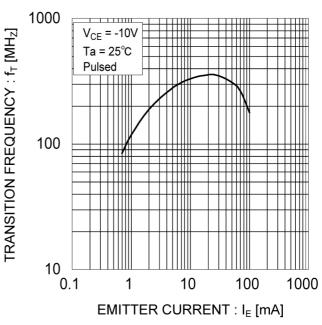


Fig.8 Gain Bandwidth Product vs.

Emitter Current



## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

<For Tr1 and Tr2 in common>

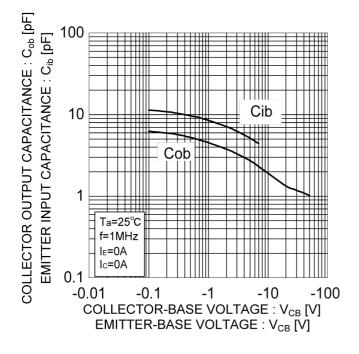
Fig.9 Emitter Input Capacitance vs.

Emitter-Base Voltage

Collector Output Capacitance vs.

Collector-Base Voltage

Fig.10 Safe Operating Area



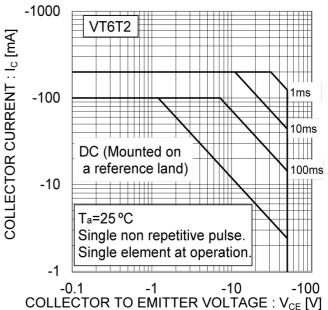
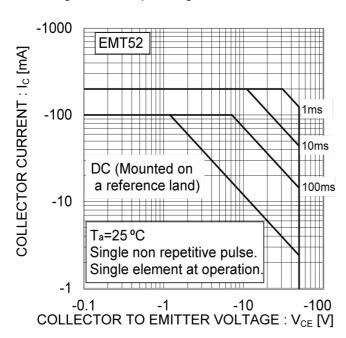
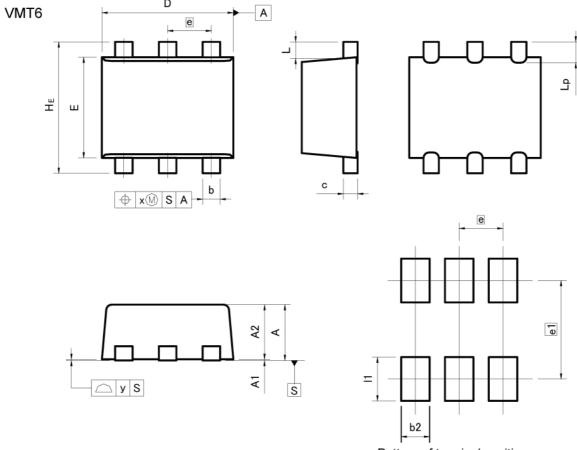


Fig.11 Safe Operating Area



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

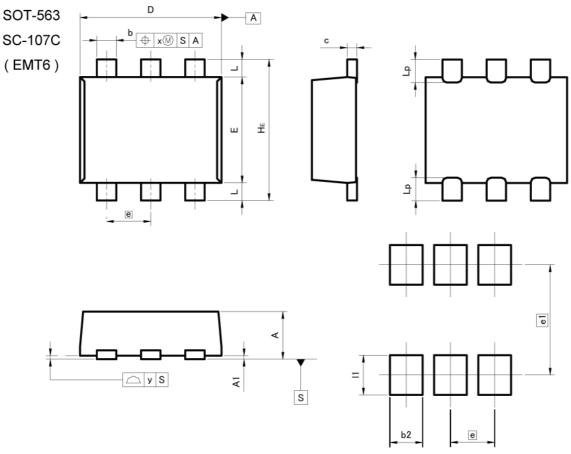
DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.05	0.000	0.002
A2	0.40	0.60	0.016	0.024
b	0.11	0.21	0.004	0.008
С	0.08	0.18	0.003	0.007
D	1.152	1.248	0.045	0.049
E	0.82	1.02	0.032	0.04
е	0.4	40	0.0	16
HE	1.152	1.248	0.045	0.049
L	0.	14	0.0	06
Lp	0.10	0.30	0.004	0.012
х	-	0.05	-	0.002
У	===	0.10	1-	0.004

DIM MILIMETERS		ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	_	0.26	I	0.010
e1	0.90		0.0	35
11	-	0.40	-	0.016

Dimension in mm/inches



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
е	0.50		0.020	
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	-	0.35	-	0.014
х	_	0.10	_	0.004
У	-	0.10	-	0.004

DIM MILIMETE		ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	-	0.37	-	0.015	
e1	1.25		0.0	49	
- 11	-	0.45	-	0.018	

Dimension in mm/inches



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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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